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<ul> <li>Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise</li> </ul>	D, DB, OR N PACKAGE (TOP VIEW)
<ul> <li>EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-μm Process</li> </ul>	$\begin{array}{c c} 1A & 1 \\ 1 & 16 \\ 1Y & 2 \\ 15 & 2A \end{array}$
<ul> <li>500-mA Typical Latch-Up Immunity at 125°C</li> </ul>	1Y U 2 15 U 2A 2Y U 3 14 U 2B GND U 4 13 U V <sub>CC</sub>
<ul> <li>Package Options Include Plastic Small-Outline (D) and Shrink Small-Outline</li> <li>(DB) Packages, and Standard Plastic</li> </ul>	$\begin{array}{c c} GND & 5 & 12 \\ 3Y & 6 & 11 \\ \end{array} \begin{array}{c} 3A \end{array}$
(DB) Packages, and Standard Plastic 300-mil DIPs (N)	4Y 47 10 3B 4B 8 9 4A

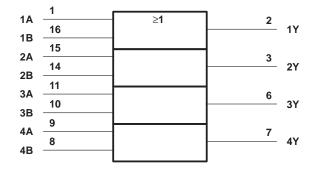
### description

This device contains four independent 2-input OR gates. It performs the Boolean function Y = A + B or  $Y = \overline{\overline{A} \cdot \overline{B}}$  in positive logic.

The 74AC11032 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each gate)						
INPUTS OUTPUT						
Α	В	Y				
Н	Х	Н				
Х	Н	н				
L	L	L				

## logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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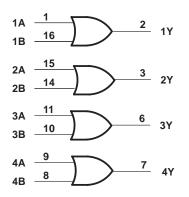
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### logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ -0.5 V to 7 VInput voltage range, $V_I$ (see Note 1)-0.5 V to $V_{CC}$ + 0.5 VOutput voltage range, $V_O$ (see Note 1)-0.5 V to $V_{CC}$ + 0.5 VInput clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) $\pm 20 \text{ mA}$ Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) $\pm 50 \text{ mA}$ Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) $\pm 50 \text{ mA}$ Continuous current through $V_{CC}$ or GND $\pm 100 \text{ mA}$ Maximum power dissipation at $T_A = 55^{\circ}$ C (in still air) (see Note 2): D package1.3 WDB package0.55 WN package1.1 W
Storage temperature range, T <sub>stg</sub> 65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150 °C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.



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			MIN	NOM	MAX	UNIT	
VCC	Supply voltage		3	5	5.5	V	
		V <sub>CC</sub> = 3 V	2.1				
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			V	
		V <sub>CC</sub> = 5.5 V	3.85				
		V <sub>CC</sub> = 3 V			0.9		
VIL	Low-level input voltage	V <sub>CC</sub> = 4.5 V			1.35	V	
		V <sub>CC</sub> = 5.5 V			1.65		
Vj	Input voltage	· · · · · · · · · · · · · · · · · · ·			VCC	V	
VO	Output voltage		0		Vcc	V	
		V <sub>CC</sub> = 3 V			-4		
ЮН	High-level output current	V <sub>CC</sub> = 4.5 V			-24	mA	
		V <sub>CC</sub> = 5.5 V			-24		
		V <sub>CC</sub> = 3 V			12		
IOL	Low-level output current	V <sub>CC</sub> = 4.5 V			24	mA	
		V <sub>CC</sub> = 5.5 V			24		
$\Delta t/\Delta v$	Input transition rise or fall rate	· · · · ·	0		10	ns/V	
ТА	Operating free-air temperature		-40		85	°C	

### recommended operating conditions

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vee	T <sub>A</sub> = 25°C		;	MIN	МАХ	UNIT	
		Vcc	MIN	TYP	MAX	WIIN	WAX	UNIT	
	I <sub>OH</sub> = -50 μA		3 V	2.9			2.9		
		4.5 V	4.4			4.4			
		5.5 V	5.4			5.4			
VOH	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V	
	I <sub>OH</sub> = -24 mA	4.5 V	3.94			3.8			
		5.5 V	4.94			4.8			
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85			
	I <sub>OL</sub> = 50 μΑ	3 V			0.1		0.1		
		4.5 V			0.1		0.1		
		5.5 V			0.1		0.1		
VOL	I <sub>OL</sub> = 12 mA	3 V			0.36		0.44	V	
	I <sub>OL</sub> = 24 mA	4.5 V			0.36		0.44		
		5.5 V		0.36		0.44			
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65		
Ц	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			±0.1		±1	μΑ	
Icc	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			4		40	μΑ	
Ci	$V_I = V_{CC}$ or GND	5 V		3.5				pF	

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	<b>₄ = 25°C</b>	;	MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	WIIIN	WAA	UNIT
<sup>t</sup> PLH	A or B	V	1.5	6.3	8.7	1.5	9.7	
<sup>t</sup> PHL	AUB	Ŷ	1.5	5.4	7.4	1.5	8	ns

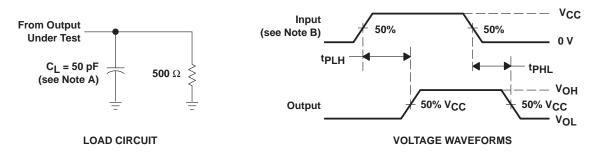
# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	ТО	T <sub>A</sub> = 25°C			MIN	мах	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX		IVIAA	UNIT
<sup>t</sup> PLH	A or B	v	1.5	4.3	6.2	1.5	6.7	
<sup>t</sup> PHL	AUB	Ŷ	1.5	3.8	5.5	1.5	5.9	ns

# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST CONDITIONS		TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per gate	C <sub>L</sub> = 50 pF,	f = 1 MHz	24	pF

## PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 3 ns, t<sub>f</sub> = 3 ns.

C. The outputs are measured one at a time with one input transition per measurement.

### Figure 1. Load Circuit and Voltage Waveforms



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